

# 33rd IEEE International Workshop on Machine Learning for Signal Processing

September 17-20, 2023 Fontana di Trevi Conference Center, Rome, Italy https://2023.ieeemlsp.org





The 33rd MLSP Workshop will be held at Roma Eventi Fontana di Trevi Conference Centre in the heart of Rome, Italy. The conference will present the most recent and exciting research advances through keynote talks, tutorials, special and regular single-track sessions, panels, and demo sessions. Prospective authors are invited to submit papers on relevant algorithms and applications including, but not limited to:

- Deep learning techniques
- Deep generative models
- Semi-/Self-supervised learning
- Adversarial machine learning
- · Graph neural networks
- · Learning from multimodal data
- Learning theory and algorithms
- Distributed/Federated learning
- Machine learning over wireless networks
- Reinforcement Learning

- Matrix factorization/completion
- Dictionary learning
- Source separation
- Independent component analysis
- · Sparsity-aware learning
- · Tensor-based signal processing
- · Information-theoretic learning
- · Pattern recognition and classification
- Feature extraction/selection/
- Applications of machine learning

# **General Chairs**

**Danilo Comminiello**, Sapienza University **Tülay Adali**, UMBC Baltimore, USA **Aurelio Uncini**, Sapienza University

# **Program Chairs**

**Wojciech Samek**, TU Berlin/ Fraunhofer HHI **Michele Scarpiniti**, Sapienza University

### **Plenary and Tutorial Chairs**

**Sergios Theodoridis**, NKU Athens **Isao Yamada**, Tokyo Institute of Technology

## **Special Session Chairs**

**Paris Smaragdis**, University of Illinois, USA **Sergio Barbarossa**, Sapienza University

# **Data Competition Chair**

Armin Iraji, Georgia State University, USA

#### **Diversity Program Chair**

Michela Paganini, DeepMind, UK

#### **Industry Liaison Chair**

Simone Scardapane, Sapienza University

# **Industry Program Chairs**

Che Lin, NTU Taiwan

Subhro Das, IBM Research, USA

#### **Student Prize Chair**

Paolo di Lorenzo, Sapienza University

#### **Finance Chair**

Massimo Panella, Sapienza University

# **Publicity Chairs**

**Daniele Grattarola**, EPFL, Switzerland **Eleonora Grassucci**, Sapienza University

#### **IEEE SPS Liaison**

Murat Akcakaya, University of Pittsburgh, USA

#### **Advisory Committee**

Zheng-Hua Tan, Aalborg University, Denmark Bhaskar Rao, UCSD, San Diego, USA Francesco A. N. Palmieri, Università degli Studi della Campania Jie Chen, NPU, Xi'an, China

# IMPORTANT DATES

- May 10, 2023: Extended deadline for regular paper submissions
- May 18, 2023: Deadline for tutorial proposals submission
- May 18, 2023: Deadline for data competition proposals submission
- July 3, 2023: Notification of paper acceptance
- July 17, 2023: Camera-ready upload

Papers should not be longer than 6 pages, including all text, figures and references, according to the Paper Submission Guidelines on https://2023.ieeemlsp.org. All the accepted and presented papers will be published in and indexed by IEEE Xplore.





